

Current Report No 30

Patent filing application for a method of heat transfer and its measurement with the UK Intellectual Property Office (UK IPO).

The Management Board of Genomtec S.A. ("Issuer") announces that today, i.e. 29 November 2021, it has been notified that a patent office has filed a patent application entitled "Thermal interface arrangement" for the technology developed by the Issuer. The described application concerns the author's method of heat transfer and measurement. The application was filed with the UK Intellectual Property Office.

The Issuer's invention may be widely used not only in diagnostics, but also in biomedical solutions, electronics or mechanics.

The described patent application secures the risk of using the same technology by other companies.

The Issuer's Management Board considered the filing of the described patent application to be confidential information, because in the case of an entity operating on the molecular diagnostics market, where new technologies represent a significant competitive advantage, it is necessary to effectively protect intellectual and industrial property. In addition, due to the possible wide use of the Genomtec's S.A. invention also outside the field of genetic diagnostics - its full protection may affect the value of the Company in the future.

Technologies of heat conduction and measurement are one of the key technology areas developed by the Issuer. For these reasons, in the opinion of the Management Board, this information meets the criteria for confidential information within the meaning of Article 17.1 of MAR.